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#### PATENT

Docket No. JCLA6968

Date: 4-19-2001

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# ASSISTANT COMMISSIONER FOR PATENTS WASHINGTON, D.C. 20231

ATTENTION: APPLICATION BRANCH

Sir:

Transmitted herewith for filing is the patent application of

Inventors: Jian-Cheng Chen, Wei-Min Hsiao

For: PACKAGE OF A CHIP WITH BEVELED EDGES

Encl	osed	are

Specification	<u>11</u>	pages
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Sheets of drawings

Recordation Form Cover sheet with 2 pages assignment.

A certified copy of Taiwan Patent Application No. \_\_ dated \_\_\_.

SIGNED declaration and power of attorney.

Return Prepaid postcard.

CLAIMS AS FILED							
FOR	NUMB	ER FII	ED	NUMBE	R EXTRA	RATE	FEE
Basic Fee						\$710.00	\$710.00
Total Claims	18		20 =	= 0	×	\$18.00	\$0.00
Independent Claims	4		3 =	= 1	×	\$80.00	\$80.00
If application contains any multiple dependent claim (s), then add			\$270.00	\$0.00			
	TOTAL	FILING	FEE		-		\$790.00

A check in the amount of \$790 cover the filing fee is enclosed.

A check in the amount of \$40.00 to cover the assignment recording fee.

A duplicate copy of this sheet is enclosed.

Jiawei Huang

Registration No. 43,330

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Assistant Commissioner for Patents Washington, D.C. 20231

Docket No.

#### **CERTIFICATE OF MAILING BY "EXPRESS MAIL"**

: JCLA6968

Applicant(s)	:	Jian-Cheng Chen, Wei-Min Hsiao
For	:	PACKAGE OF A CHIP WITH BEVELED EDGES
"Express Mail"	:	EL608224368US
Mailing Label No.		
Date of Deposit	:	April 19, 2001
I hereby certify that the accompanying		

Transmittal in Duplicate; Specification <u>11 pages</u>, <u>2</u> sheets of drawings; **SIGNED** Declaration and Power of Attorney <u>2</u> pages; Recordation Form Cover Sheet and Assignment <u>3</u> pages; Checks for Filing Fee(s); Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

Jiawei Huang